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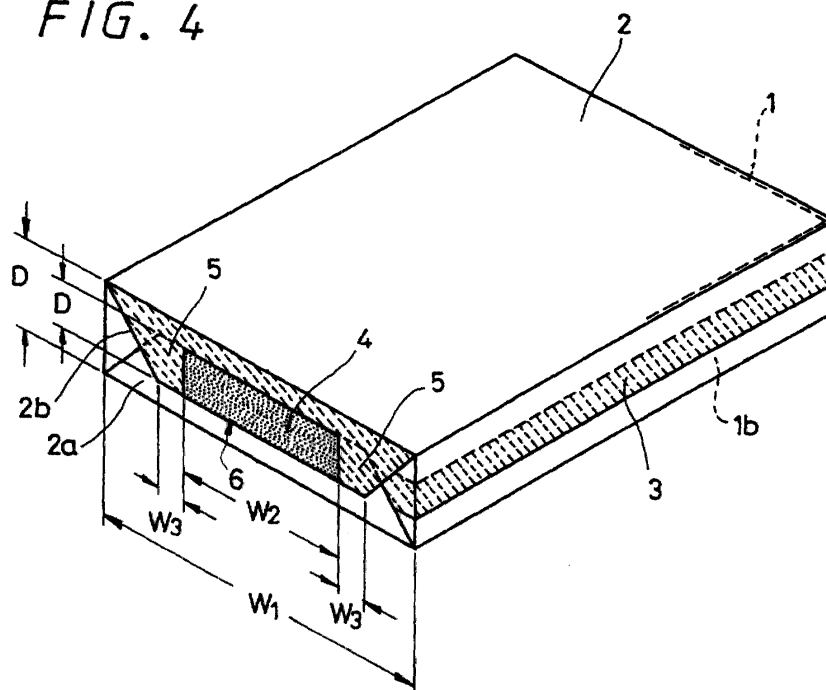
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(54) **Packing assembly**

(57) A packing assembly in which a cassette case (1), having a tape cassette stored therein, is wrapped by a transparent outside wrapping film (2) having a front seal portion (3) in which the outside wrapping film (2) is overlapped at the body front (1b) of the cassette case (1) and sealed by melt-welding. A solid-printed portion

(4) formed on the film fold upper member (2b) of one side portion, serves as a tear-strip portion (6) to open the outside wrapping film. The remaining portion of the film fold upper member (2b) forms a side seal portion (5) in which the film fold upper member (2b) except the solid-printed portion (4) is sealed to the outside wrapping film of the lower layer by melt-welding.

FIG. 4





European Patent
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EUROPEAN SEARCH REPORT

Application Number
EP 01 40 0966

DOCUMENTS CONSIDERED TO BE RELEVANT			
Category	Citation of document with indication, where appropriate, of relevant passages	Relevant to claim	CLASSIFICATION OF THE APPLICATION (Int.Cl.7)
X	US 5 749 466 A (SEKI SEIZO) 12 May 1998 (1998-05-12) * column 2, line 58 - line 68 * * column 3, line 1 - line 2 * * column 3, line 58 - line 61 * * column 4, line 1 - line 9 * * column 4, paragraph 2 * * column 4, paragraph 6 * * column 5, paragraph 3 * * column 4, paragraph 5 * * figures 1-5 *	1-5	B65D75/08 B65D75/58
X	US 5 921 464 A (SEKI SEIZO) 13 July 1999 (1999-07-13) * column 2, line 65 - line 68; figure 5 * * column 3, paragraph 1 - paragraph 2 * * column 3, paragraph 4 * * column 3, paragraph 6 * * column 3, paragraph 8 - paragraph 10 * * column 4, paragraph 4 *	1-5	
A	EP 0 835 824 A (SONY CORP) 15 April 1998 (1998-04-15) * column 1, paragraph 8 * * column 3, line 39 - line 52 * * column 3, line 57 - line 58 * * column 4, line 1 - line 10 * * column 5, paragraph 3 - paragraph 4 * * figures 2-10 *	1-5	TECHNICAL FIELDS SEARCHED (Int.Cl.7) B65D
The present search report has been drawn up for all claims			
Place of search BERLIN		Date of completion of the search 2 December 2002	Examiner Nistor, L
CATEGORY OF CITED DOCUMENTS X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document		T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document	

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**ANNEX TO THE EUROPEAN SEARCH REPORT
ON EUROPEAN PATENT APPLICATION NO.**

EP 01 40 0966

This annex lists the patent family members relating to the patent documents cited in the above-mentioned European search report.
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